

## AIN SHAMS UNIVERSITY FACULTY OF ENGINEERING CAIRO-EGYPT

Computer and Systems Engineering Department

# **Graph-Based Approach for Symmetry Detection**

#### A Thesis

Submitted in Partial Fulfillment for the Requirements of the Degree of Master of Science in Electrical Engineering

### **Submitted by**

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# **STATEMENT**

This Thesis is submitted to Ain Shams University in partial fulfillment of the degree of Master of Science in Electrical Engineering.

The work included in this thesis was carried out by the author in the department of Computer and Systems Engineering, Ain Shams University.

No part of this Thesis has been submitted for a degree or a qualification at any other university or institute.

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#### **ABSTRACT**

Symmetry detection plays an important role in many applications. One of those applications is detecting symmetries of the Integrated Circuits layouts. Symmetry can be presented excessively in one layout design as it provides high efficiency in the circuit performance. Maintaining the geometrical symmetry of the circuit components during the layout compaction has great impact on analog circuit performance and poses great challenges to analog layout automation. Device matching and symmetry are very important in layout design of high performance analog circuits. The aim of this thesis is to find an efficient solution for detecting symmetry in Integrated Circuits layout. Approaches used to detect IC layout symmetry depend on extracting information from the circuit design. A new approach is presented to detect IC layout symmetry between polygons using image processing. In this thesis, a novel method for detecting symmetry is introduced. Taking advantage of the type of images used of layout designs to have more efficient symmetry detection algorithm.

The algorithm is implemented by C++ and tested using several analog layout designs. The new algorithm is successful in detecting symmetry in layout images compared to other ones. This approach detects translation, scale, rotation and partial symmetries in the IC layout design. In comparison to famous symmetry detection algorithms like SIFT, the new approach succeeds to detect symmetric polygons with higher speed and more accurate results.

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